



I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on January 3, 2003.

John J. Kelly

Reg. No.: 29,182

*John J. Kelly, Jr.*

Examiner : Sikyin Ip  
Art Unit : 1742  
Docket No.: 52437/24

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Y. YOSHITOMI et al.

Serial No.: 09/783,408

Filed : February 14, 2001

For : THICK GRAIN-ORIENTED ELECTRICAL STEEL SHEET  
EXHIBITING EXCELLENT MAGNETIC PROPERTIES

Commissioner for Patents  
Washington, D.C. 20231

**RECEIVED**

JAN 09 2003

**TC 1700**

**AMENDMENT**

Sir:

Kindly amend the above-identified patent application as follows.

**In The Claims**

Cancel claims 1-3.

~~Add the following new claims 4-6.~~

91  
--4. (New) In a method for producing a thick grain-oriented electrical steel sheet with excellent properties, the method comprising:

preparing a slab comprising, by weight, 0.025 - 0.075% of C, 2.5 - 4.5% of Si, optionally one or more inhibitor-forming elements selected from the group consisting of Al, N, Mn, S, Se, Sb, B, Cu, Nb, Cr, Sn, Ti

2b  
B1